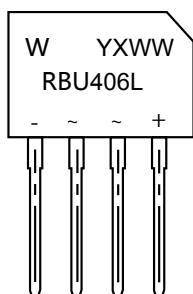


Low VF Bridge Rectifiers



Features

- Glass Passivated Chip Junction
- Low I_{RRM}
- Low V_F
- High V_{RRM}

Benefits

- Case: RBU
- Terminals: Solderable Per MIL-STD-750
- Reduced power loss and switching transistor
- Reduced snubbing

PINNING

| PIN | DESCRIPTION |
|-----|--------------------|
| 1 | Input Pin (~) |
| 2 | Input Pin (~) |
| 3 | Output Anode (+) |
| 4 | Output Cathode (-) |

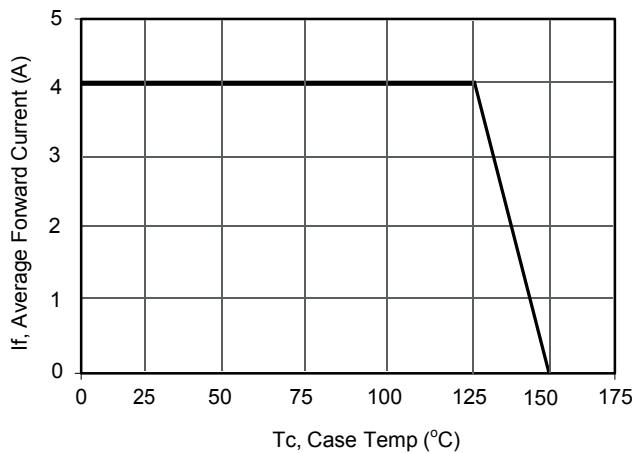
Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

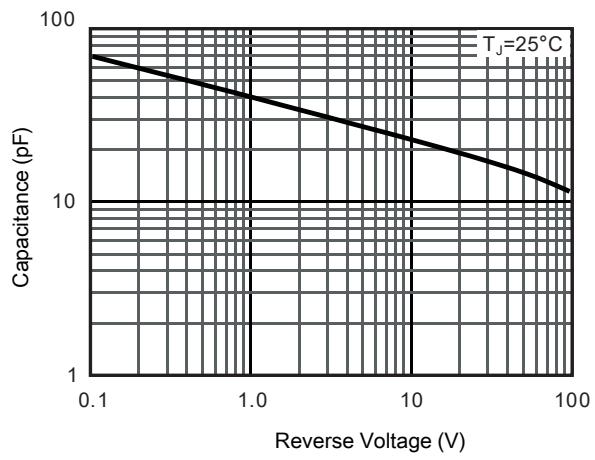
Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

| Parameter | Symbols | RBU406L | Units |
|--|-----------------------------------|------------|-------|
| Maximum Repetitive Peak Reverse Voltage | V _{RRM} | 600 | V |
| Maximum RMS voltage | V _{RMS} | 420 | V |
| Maximum DC Blocking Voltage | V _{DC} | 600 | V |
| Average Rectified Output Current | I _o | 4.0 | A |
| Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method) | I _{FSM} | 120 | A |
| Type Forward Voltage at 2.0 A | V _F | 0.85 | V |
| Maximum Forward Voltage at 2.0 A | | 0.95 | |
| Maximum DC Reverse Current @T _A =25 °C at Rated DC Blocking Voltage @T _A =125 °C | I _R | 10 500 | μA |
| Typical Junction Capacitance (Note1) | C _j | 25 | pF |
| Operating and Storage Temperature Range | T _j , T _{stg} | -55 ~ +150 | °C |
| Note: 1. Measured at 1MHz and applied reverse voltage of 4 VDC. | | | |
| 2. Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad | | | |

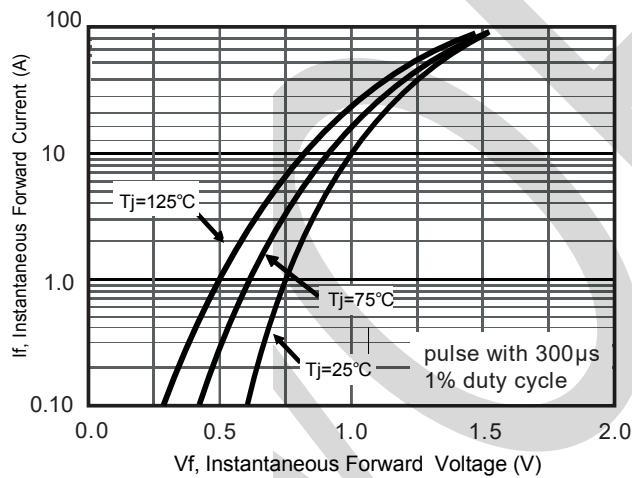
RATINGS AND CHARACTERISTICS CURVES (TA = 25 °C unless otherwise noted)



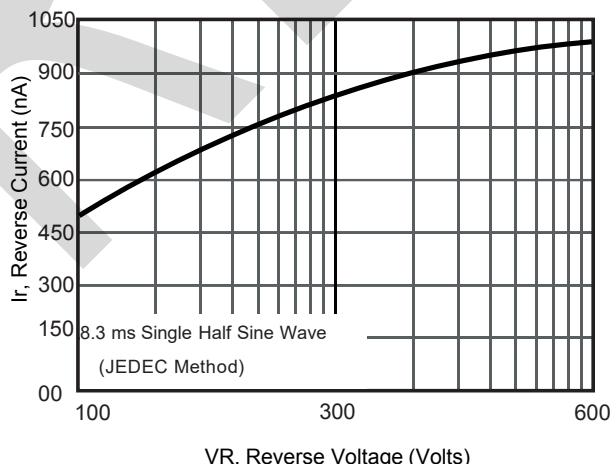
Current Derating, Case



Typical Junction Capacitance



Typical Forward Voltage



Typical Reverse Current

PACKAGE OUTLINE DIMENSIONS

